Properties **Test conditions** Value Unit Tol. 1 ±0.2 V_{RMS}, 1 kHz ±10 % @ С Capacitance 4.7 μF ±20% 25 °C 4.0 V_{R} **Rated Voltage** 6.3 V (DC) max. 2.2 1 ±0.2 V_{RMS}, 1 kHz ±10 % @ 25 °C DF **Dissipation Factor** 10 % max. $0,6 \pm 0,2$ Insulation R_{ISO} Apply V_R for 120 s max. 0.02 GΩ min. Resistance Precondition for Class II MLCC measurement: Apply a preheat treatment @150 \pm 10 °C for 1 hour. The measurement should be applied after 24 \pm 2 hrs the part was stored under ambient conditions. **3,2** ^{+0,3} -0,1 There is not any precondition necessary for Class I MLCC. Scale 10:1 ç ά Έ ဖ Schematic: **General Information:** General Purpose MLCC , 4 6 0 0 Ceramic Type X5R Class II Q **Temperature Coefficient** ± 15 % max. **Operating Temperature** -55 up to +85 °C **Storage Conditions** 5 °C up to + 35 °C; 10 % up to 75 % RH (in original packaging) Moisture Sensitivity Level (MSL) 1 5 sec. @ 250 % V_R; Charge & Discharge Current <50 mA **Dielectric Strength** Test conditions of electrical properties: +20 °C, 35 % RH if not specified differently Scale - 10:1 FIT according to separate documentation CHECKED GENERAL TOLERANCE REVISION DATE (YYYY-MM-DD) PROJECTION METHOD FPu 003.000 2022-11-25 DIN ISO 2768-1m G DESCRIPTION TECHNICAL REFERENCE RoHS COMPLIANT REACH HALOGEN **WCAP-CSGP** Ceramic Capacitors X5R1206475M6R3DFCT10000 Würth Elektronik eiSos GmbH & Co. KG 1206 ORDER CODE EMC & Inductive Solutions WÜRTH Max-Eyth-Str. 1 885012108001 74638 Waldenburg ELEKTRONIK Germany MORE THAN Tel. +49 (0) 79 42 945 - 0 SIZE/TYPE BUSINESS UNIT STATUS PAGE YOU EXPECT www.we-online.com 1206 Valid 1/8 eiCap

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eiSos@we-online.com

Recommended Land Pattern: [mm]

Electrical Properties:

Mechanical Properties

Properties	Definition	
Adhesive Strength of Termination	0201	10 ±1 sec; 2 N
	0402 & 0603	10 ±1 sec; 5 N
	> 0603	10 ±1 sec; 10 N
Vibration Resistance		all 3 directions, 2 hours each @ 10 - 55 Hz/ min., amplitude 0.75 mm or 10 g
Resistance to Solder Heat	Specific	Refer to Soldering Profile

Certification:

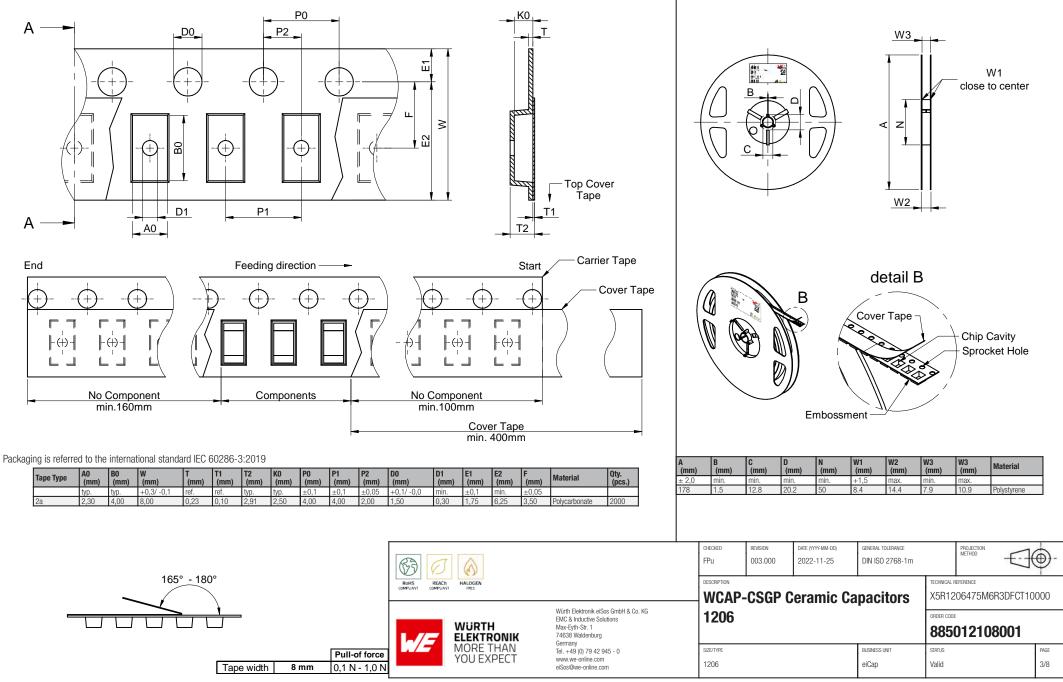
RoHS Approval	Compliant [2011/65/EU&2015/863]
REACh Approval	Conform or declared [(EC)1907/2006]
Halogen Free	Conform [JEDEC JS709B]
Halogen Free	Conform [IEC 61249-2-21]

	Retts Retts Retts Retts Brits Retts HALGEN WURTH ELEKTRONIK Würth Elektronik elSos GmbH & Co. KG ELEKTRONIK MORE THAN Material		CHECKED FPu	REVISION 003.000	DATE (YYYY-MM-DD) 2022-11-25	GENERAL TOLERANCE DIN ISO 2768-1 m		PROJECTION METHOD]@-
			WCAP-CSGP Ceramic Capacitors				TECHNICAL REFERENCE X5R1206475M6R3DFCT10000		
			1206			_	ORDER CODE	12108001	
	MORE THAN YOU EXPECT	Germany Tel. +49 (0) 79 42 945 - 0 www.we-online.com	SIZE/TYPE			BUSINESS UNIT eiCap	status Valid		PAGE 2/8

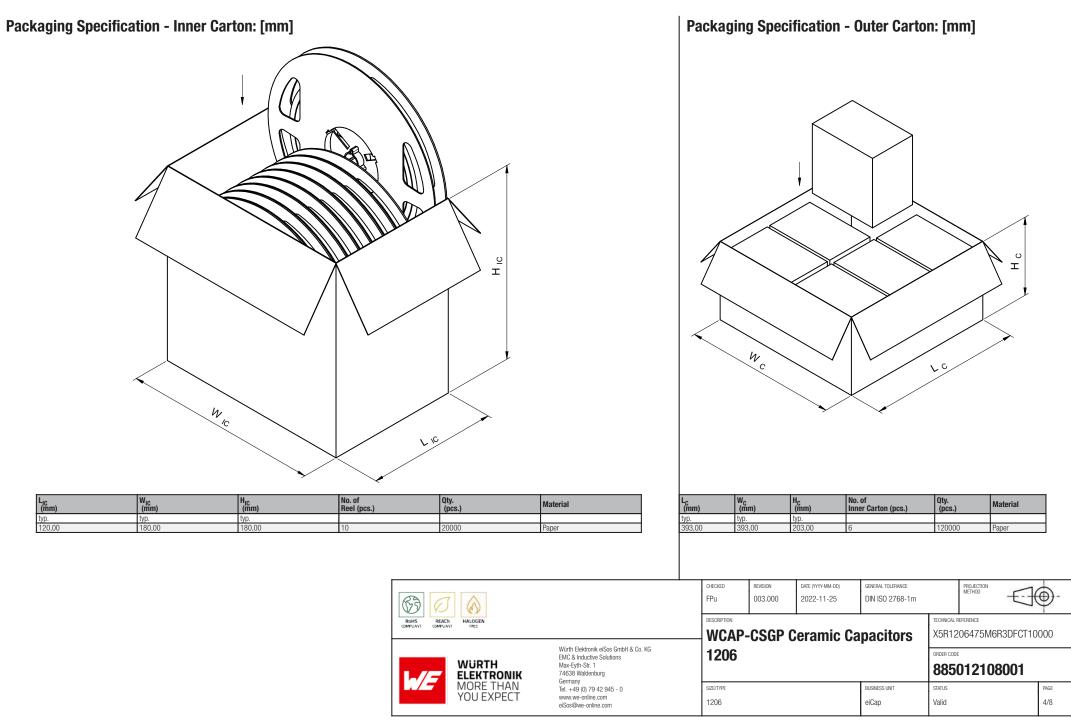
This electronic component has been designed and developed for usage in general electronic equipment only. This product is not authorized for use in equipment where a higher safety standard and reliability standard and reliability standard is especially required or where a failure of the product is reasonably expected to cause severe personal injury or death, unless the parties have executed an agreement specifically governing such use. Moreover Würth Elektronik elSos GmbH & Co KG products are neither designed in intended for use in areas such as military, aerospace, availation, nuclear controls, submarine, transportation signal, disaster prevention, medical, public information network etc... Würth Elektronik elSos GmbH & Co KG must be informed about the intent of such usage before the design-in stage. In addition, sufficient reliability evaluation checks for safety must be performed on every electronic component which is used in electronic advicual transport. Wurth Elektronik elSos GmbH & Co KG must be information.

Packaging Specification - Tape: [mm]

Packaging Specification - Reel: [mm]



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Classification Reflow Profile for SMT components:



Classification Reflow Soldering Profile:

Profile Feature		Value
Preheat Temperature Min	T _{s min}	150 °C
Preheat Temperature Max	T _{s max}	200 °C
Preheat Time $\rm t_s$ from $\rm T_{smin}$ to $\rm T_{smax}$	t _s	60 - 120 seconds
Ramp-up Rate (T _L to T _P)		3 °C/ second max.
Liquidous Temperature	TL	217 °C
Time t_L maintained above T_L	tL	60 - 150 seconds
Peak package body temperature	Т _р	$T_p \le T_c$, see Table below
Time within 5°C of actual peak temperature	t p	20 - 30 seconds
Ramp-down Rate (T _P to T _L)		6 °C/ second max.
Time 25°C to peak temperature		8 minutes max.

refer to IPC/ JEDEC J-STD-020E

Package Classification Reflow Temperature (T_c):

Properties	Volume mm ³ <350	Volume mm ³ 350-2000	Volume mm ³ >2000
PB-Free Assembly I Package Thickness < 1.6 mm	260 °C	260 °C	260 °C
PB-Free Assembly Package Thickness 1.6 mm - 2.5 mm	260 °C	250 °C	245 °C
PB-Free Assembly I Package Thickness > 2.5 mm	250 °C	245 °C	245 °C

refer to IPC/ JEDEC J-STD-020E

	./_	MORE THAN YOU EXPECT	Tel. +49 (0) 79 42 945 - 0 www.we-online.com eiSos@we-online.com	SIZE/TYPE 1206			BUSINESS UNIT eiCap	status Valid		1	PAGE 5/8
	Würth Elektronik eiSos Grobh & Co. KG EMC & Inductive Solutions Max-Eyth-Str. 1 74638 Waldenburg Germany		1206				ORDER CODE	012108	8001		
			WCAP-	-CSGP C	eramic Ca	pacitors	TECHNICAL R X5R12	eference 06475M6F	R3DFCT100	000	
6			CHECKED FPu	REVISION 003.000	DATE (YYYY-MM-DD) 2022-11-25	general tolerance DIN ISO 2768-1m		PROJECTION METHOD	=	∲ -	

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Cautions and Warnings:

The following conditions apply to all goods within the product series of MLCCs of Würth Elektronik eiSos GmbH & Co. KG:

General

- This electronic component is designed and manufactured for use in general electronic equipment.
- Würth Elektronik must be asked for a written approval (following the certain PPAP level procedure) before incorporating the components
 into any equipment in the field such as military, aerospace, aviation, nuclear control, submarine, transportation (automotive control, train
 control, ship control), transportation signal, disaster prevention, medical, public information network etc. where higher safety and
 reliability are especially required and/or if there is the possibility of direct damage or human injury.
- · Electronic components that will be used in safety-critical or high-reliability applications, should be pre-evaluated by the customer.
- Direct mechanical impact to the product shall be prevented as material of the body, pins or termination could flake or in the worst case
 it could break.
- Avoid any water or heavy dust on capacitors surface, which may cause electrical leakage, damage, overheating or corrosion.
- Würth Elektronik products are qualified according to international standards, which are listed in each product reliability report. Würth
 Elektronik does not warrant any customer qualified product characteristic, beyond Würth Elektronik specifications, for its validity and
 sustainability over time.
- The responsibility for the applicability of the customer specific products and use in a particular customer design is always within the
 authority of the customer. All technical specifications for standard products also apply to customer specific products.
- The component is designed and manufactured to be used within the datasheet specified values. If the usage and operation conditions specified in the datasheet are not met, the wire insulation may be damaged or dissolved.
- Do not drop or impact the components, the component may be damaged
- The capacitance tolerance as specified within the datasheet is only valid on the date of delivery and according specified measurement criteria

Product specific

Storage conditions

- A storage of Würth Elektronik products for longer than 12 months is not recommended. Within other effects, the terminals may suffer
 degradation, resulting in bad solderability. Therefore, all products shall be used within the period of 12 months based on the day of
 shipment.
- Do not expose the components into direct sunlight.
- The storage condition in the original packaging is defined according to DIN EN 61760-2.
- The environment in which the capacitors are operated and stored has to have atmospheric characteristics and must be free of dew condensation and toxic gases (e.g. chlorine, ammonia, sulfur, hydrogen sulphide and hydrogen sulfate).
- The storage conditions stated in the original packaging apply to the storage time and not to the transportation time of the components

Packaging:

• The packaging specifications apply only to purchase orders comprising whole packaging units. If the ordered quantity exceeds or is lower than the specified packaging unit, packaging in accordance with the packaging specifications cannot be ensured.

Operating climatic conditions

- · Do not exceed the lower nor the upper specified temperature under no circumstances.
- · Be aware that the specified capacitance tolerance is only valid at the date of delivery.
- Do not use the capacitors under high humidity, high temperature nor under high or low atmospheric pressure which may affect capacitors reliability.
- Surface temperature including self-heating must be kept below the maximum operating temperature.
- The temperature rise of the capacitor's temperature compared to ambient temperature shall be below 20°C.

Operating load conditions

- Operating voltage across the terminals including AC and DC peaks and AC or pulse overshooting, Vp-p, as well as irregular voltage because of resonance or switching must be below the rated voltage.
- Due to self-heating the reliability of the capacitor may be reduced, if high frequency AC or pulse is applied.
- Consider carefully possible specific changes of electrical characteristics like capacitance over temperature, voltage and time as well as the specific performance over frequency for the actual use conditions.

Design of the PCB

- The chip capacitor shall be located to minimize any possible mechanical stress from deflection or board wrap.
- It is recommended to position the chip capacitor in parallel to slits and perforations and as far away from slits, perforations, separation
 points, screw holes, frames and edges of the PCB to avoid mechanical stress.
- The PCB design (e.g. land pattern design and grounding planes) must be evaluated for each individual circuit to achieve the optimal soldering results.

Mounting

- Adjust the bottom dead center of the mounting head not to press on the PCB surface.
- Provide support from the bottom side of the PCB by a support pin for minimizing the impact energy from the mounting head.

Adhesive

- The adhesive should have sufficient coating and viscosity and should harden rapidly.
- The adhesive should be strong enough to hold parts on the board during the mounting and solder process and should have sufficient strength at high temperatures.

Reverse Reverse Reach Reach Reach Reach Reach Reverse Reverse Reverse Reverse Reach Reach Reach Reverse Revers		CHECKED FPu	REVISION 003.000	DATE (YYYY-MM-DD) 2022-11-25	GENERAL TOLERANCE DIN ISO 2768-1 m		PROJECTION METHOD	-	
							TECHNICAL REFERENCE X5R1206475M6R3DFCT10000		
		1206			-	ORDER CODE	012108001		
MORE THAN YOU EXPECT	Tel. +49 (0) 79 42 945 - 0 www.we-online.com elSos@we-online.com	size/type 1206			BUSINESS UNIT eiCap	status Valid		PAGE 6/8	

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- The adhesive should have corrosion resistance, excellent insulation characteristics and no emission of toxic gasses nor any effect on the human body
- Do not use too much adhesive to avoid pollution of the soldering pads.

Soldering

- The solder profile must comply with the technical product specifications. All other profiles will void the warranty.
- All other soldering methods are at the customer's own risk.
- Strong forces which may affect the coplanarity of the component's electrical connection with the PCB (i.e. pins), can damage the part, resulting in avoid of the warranty.
- Customer needs to ensure that the applied solder paste, the paste thickness and solder conditions are applicable to guarantee a
 sufficient solder result according to the relevant criteria of IPC-A-610.
- Excessive amount of solder may lead to higher tensile force and chip cracking. Insufficient amount of solder may detach the capacitor due to defective contacts.
- Do not use excessive nor insufficient flux.
- Provide enough washing when water-soluble flux is used.
- For reflow soldering, two times limitation is recommended.
- Wave soldering is recommended only for the following case sizes: 0603 and 0805, with maximal thickness of 0.85 mm.

Cleaning and Washing

- Washing agents used during the production to clean the customer's application, might damage or change the characteristics of the wire insulation body, the marking or the plating. Washing agent could have a negative effect on the long-term functionality of the product.
- Avoid Halogen in the flux or any contaminated flux as well as excessively high ultrasonic cleaning.

Coating, molding and potting of the PCB

- If the product is potted in the costumer's application, the potting material might shrink or expand during and after hardening. Shrinking
 could lead to an incomplete seal, allowing contaminants into the body and termination. Expansion could damage the body or
 termination. We recommend a manual inspection after potting to avoid these effects.
- When coating and molding the PCB, verify the quality influence on the capacitor.
- Verify the curing temperature and assure that there is no harmful decomposing or reaction gas emission during curing.
- Do not exceed the maximal temperature rise of 20°C.

Handling

- After soldering, please pay attention not to bend, twist or distort the PCB in handling and storage.
- Avoid excessive pressure during the functional check of the PCB.
- Avoid bending stress while breaking the PCB.
- After mounting, avoid piling up PCBs to avoid hitting the chip capacitor of another board.

Ronfs COMPLIANT Image: Compliant in the complexity of the comp		CHECKED FPu	REVISION 003.000	DATE (YYYY-MM-DD) 2022-11-25	general tolerance DIN ISO 2768-1m		PROJECTION METHOD	-
		DESCRIPTION	CSGP C	eramic Ca	pacitors	technical r X5R12	IEFERENCE 106475M6R3DFCT1	0000
		1206				ORDER CODE		
	Max-Eyth-Str. 1					8850	012108001	

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These cautions and warnings comply with the state of the scientific and technical knowledge and are believed to be accurate and reliable. However, no responsibility is assumed for inaccuracies or incompleteness.

Important Notes

The following conditions apply to all goods within the product range of Würth Elektronik eiSos GmbH & Co. KG:

1. General Customer Responsibility

Some goods within the product range of Würth Elektronik eiSos GmbH & Co. KG contain statements regarding general suitability for certain application areas. These statements about suitability are based on our knowledge and experience of typical requirements concerning the areas, serve as general guidance and cannot be estimated as binding statements about the suitability for a customer application. The responsibility for the applicability and use in a particular customer design is always solely within the authority of the customer. Due to this fact it is up to the customer to evaluate, where appropriate to investigate and decide whether the device with the specific product characteristics described in the product specification is valid and suitable for the respective customer application or not.

2. Customer Responsibility related to Specific, in particular Safety-Relevant Applications

It has to be clearly pointed out that the possibility of a malfunction of electronic components or failure before the end of the usual lifetime cannot be completely eliminated in the current state of the art, even if the products are operated within the range of the specifications. In certain customer applications requiring a very high level of safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health it must be ensured by most advanced technological aid of suitable design of the customer application that no injury or damage is caused to third parties in the event of malfunction or failure of an electronic component. Therefore, customer is cautioned to verify that data sheets are current before placing orders. The current data sheets can be downloaded at www.we-online.com.

3. Best Care and Attention

Any product-specific notes, cautions and warnings must be strictly observed. Any disregard will result in the loss of warranty.

4. Customer Support for Product Specifications

Some products within the product range may contain substances which are subject to restrictions in certain jurisdictions in order to serve specific technical requirements. Necessary information is available on request. In this case the field sales engineer or the internal sales person in charge should be contacted who will be happy to support in this matter.

5. Product R&D

Due to constant product improvement product specifications may change from time to time. As a standard reporting procedure of the Product Change Notification (PCN) according to the JEDEC-Standard inform about minor and major changes. In case of further queries regarding the PCN, the field sales engineer or the internal sales person in charge should be contacted. The basic responsibility of the customer as per Section 1 and 2 remains unaffected.

6. Product Life Cycle

Due to technical progress and economical evaluation we also reserve the right to discontinue production and delivery of products. As a standard reporting procedure of the Product Termination Notification (PTN) according to the JEDEC-Standard we will inform at an early stage about inevitable product discontinuance. According to this we cannot guarantee that all products within our product range will always be available. Therefore it needs to be verified with the field sales engineer or the internal sales person in charge about the current product availability expectancy before or when the product for application design-in disposal is considered. The approach named above does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.

7. Property Rights

All the rights for contractual products produced by Würth Elektronik eiSos GmbH & Co. KG on the basis of ideas, development contracts as well as models or templates that are subject to copyright, patent or commercial protection supplied to the customer will remain with Würth Elektronik eiSos GmbH & Co. KG does not warrant or represent that any license, either expressed or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, application, or process in which Würth Elektronik eiSos GmbH & Co. KG components or services are used.

8. General Terms and Conditions

Unless otherwise agreed in individual contracts, all orders are subject to the current version of the "General Terms and Conditions of Würth Elektronik eiSos Group", last version available at www.we-online.com.

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			WCAP-CSGP Ceramic Capacitors					TECHNICAL REFERENCE X5R1206475M6R3DFCT10000		
		Würth Elektronik eiSos GmbH & Co. KG EMC & Inductive Solutions Max-Eyth-Str. 1 74638 Waldenburg Gergrage	1206			_	ORDER CODE	0121080	01	
	MORE THAN YOU EXPECT	Germany Tel. +49 (0) 79 42 945 - 0 www.we-online.com eiSos@we-online.com	SIZE/TYPE 1206			BUSINESS UNIT eiCap	status Valid		1	PAGE 8/8

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